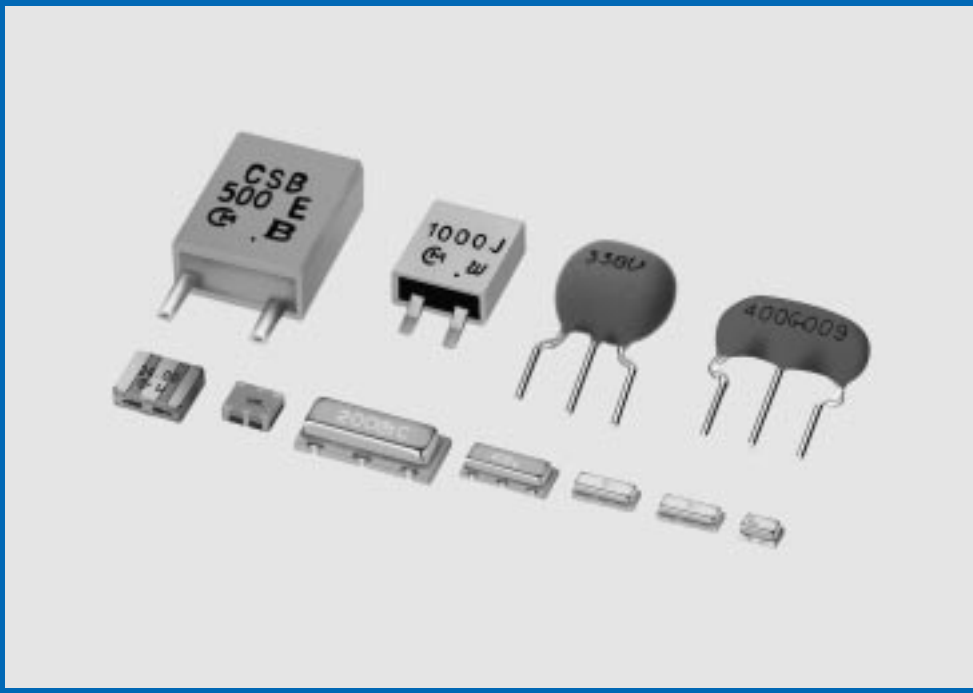
⚠Note Please read rating and ⚠CAUTION (for storage and operating, rating, soldering and mounting, handling) in this PDF catalog to prevent smoking and/or burning, etc.
This catalog has only typical specifications. Therefore, you are requested to approve our product specification or to transact the approval sheet for product specificaion before ordering.

Ceramic Resonators (CERALOCK®)

CERAMIC RESONATORS (CERALOCK®)



GLOBAL PART NUMBERS
JUNE 2001

muRata Innovator in Electronics
Murata
Manufacturing Co., Ltd.

Cat.No.P16E-14

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CONTENTS

CERALOCK® and "CERALOCK" in this catalog are the trademarks of Murata Manufacturing Co., Ltd.

● Part Numbering

CERALOCK® (MHz)

(Global Part Number) **CS** ❶ **T** ❷ **CV** ❸ **16M0** ❹ **X53** ❺ ******* ❻ **-R0** ❼

❶Product ID

Product ID	
CS	Ceramic Resonators

❷Frequency/Capacitance

Code	Frequency/Capacitance
A	MHz No capacitance built-in
T	MHz Built-in Capacitance

❸Structure/Size

Code	Structure/Size
LA	Lead Type
LS	Round Lead Type
CC	Cap Chip Type
CR/CE/CG	Small-cap Chip Type
CV	Monolithic Chip Type
CW	Small Monolithic Chip Type

❹Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (MHz). Decimal point is expressed by capital letter "**M**".

❺Design

Code	Design
G□□	Thickness Shear mode
T/V□□	Thickness Expander mode
X□□	Thickness Expander mode (3rd overtone)

□□ indicates initial frequency tolerance and load capacity.

❻Individual Specification

Code	Individual Specification
*******	Three-digit alphanumerics express "Individual Specification".

With standard products, "❻Individual Specification" is omitted, and "❼Package Specification Code" is carried up.

❼Packaging

Code	Packaging
-B0	Bulk
-A0	Radial Taping H_0=18mm
-A1	Radial Taping H_0=16mm
-R0	Plastic Taping ø=180mm
-R1	Plastic Taping ø=330mm

Radial taping is applied to lead type and plastic taping to chip type.

CERALOCK® (kHz)

(Global Part Number) **CS** ❶ **B** ❷ **FB** ❸ **1M00** ❹ **J58** ❺ ******* ❻ **-R1** ❼

❶Product ID

Product ID	
CS	Ceramic Resonators

❷Frequency/Capacitance

Code	Frequency/Capacitance
B	kHz No capacitance built-in

❸Structure/Size

Code	Structure/Size
LA	Two-Terminal Lead Type
FB	SMD Type

❹Nominal Center Frequency

Expressed by four-digit alphanumerics. The unit is in hertz (Hz). Capital letter "**K**" following three figures expresses the unit of "kHz".

❺Design

Code	Design
E□□	Area Expansion mode
J□□	Area Expansion mode (Closed Type)

□□ indicates initial frequency tolerance and load capacitance.

❻Individual Specification

Code	Individual Specification
*******	Three-digit alphanumerics express "Individual Specification".

With standard products, "❻Individual Specification" is omitted, and "❼Package Specification Code" is carried up.

❼Packaging

Code	Packaging
-B0	Bulk
-R1	Plastic Taping ø=330mm

Ceramic Resonators (CERALOCK®)

Chip Type Three-Terminals CSTCC/E/G/R/V/W Series

Chip "CERALOCK" with built-in load capacitance in an extremely small package.
MURATA's package technology expertise has enabled the development of the Chip "CERALOCK" with built-in load capacitors.
High-density mounting can be realized because of the small package and the elimination of the need for an external load capacitor.

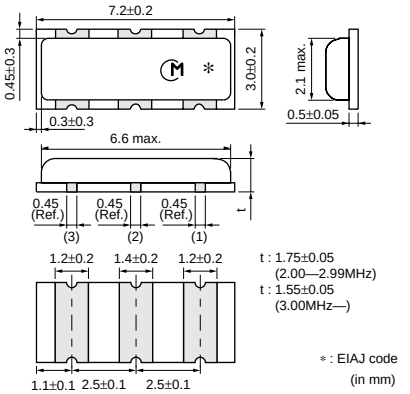
■ Features

1. Oscillation circuits do not require external load capacitors.
2. The series is available in a wide frequency range.
3. The resonators are extremely small and have a low profile.
4. No adjustment is necessary for oscillation circuits.

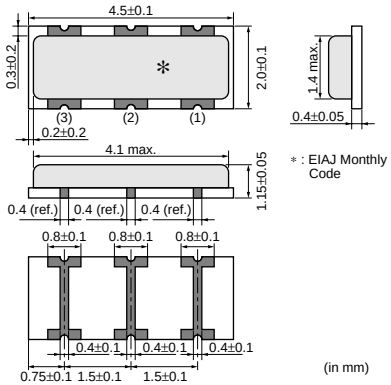
■ Applicatons

- Clock oscillators for microprocessors.
- Electronic control circuits for small electronic equipment such as hand held movie.
- Audio-visual applications (Camcorder, Remote Controller, etc.)
- Office automation equipments (DVD, CD-ROM, HDD, FDD, etc.)
- Automotive electronics. (CSTCC_G_A series, CSTCR_G_A series, CSTCE_G_A series, CSTCV_X_Q series)
- Dual Tone Multi Frequency (DTMF) generator for cordless telephones.

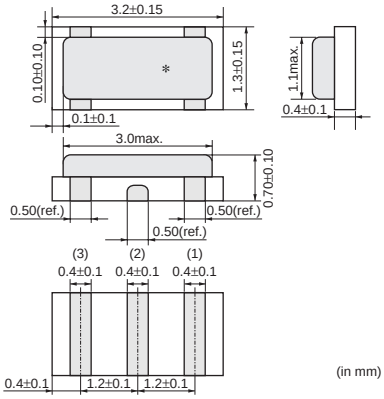
CSTCC_G(_A)
2.00-3.99MHz



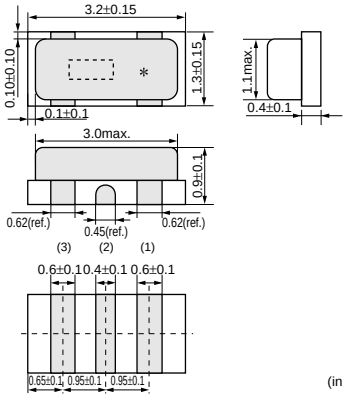
CSTCR_G(_A)
4.00-7.99MHz



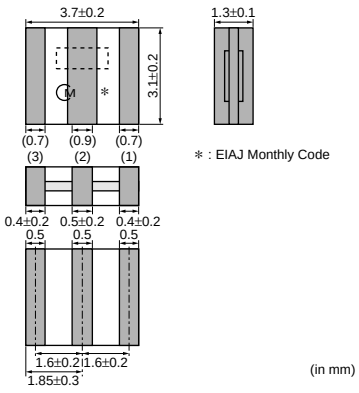
CSTCE_G(_A)
8.00-12.50MHz



CSTCE_V
12.51-19.99MHz



CSTCV_X_Q
14.70-70.00MHz



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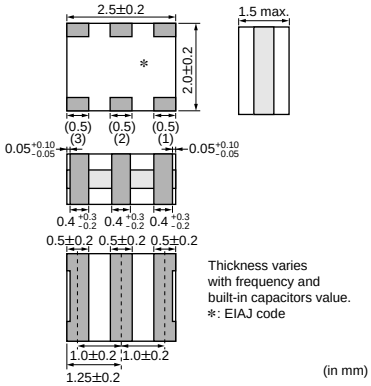
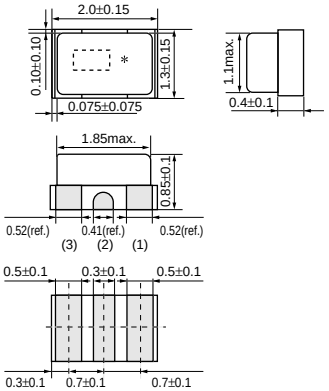
CSTCW_X
20.00-70.00MHz



(in mm)

CSTCG_V
20.00-33.86MHz
(Ultra small)

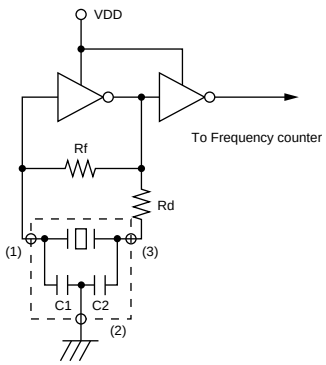


(in mm)

Part Number	Oscillating Frequency (MHz)	Initial Tolerance (%)	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSTCC_G	2.00 to 3.99	±0.5	±0.3	-20 to 80	±0.3	For consumer electronics
CSTCC_G_A	2.00 to 3.99	±0.5	±0.4	-40 to 125	±0.3	For automotive electronics
CSTCR_G	4.00 to 7.99	±0.5	±0.2	-20 to 80	±0.1	For consumer electronics
CSTCR_G_A	4.00 to 7.99	±0.5	±0.3	-40 to 125	±0.1	For automotive electronics
CSTCE_G	8.00 to 12.50	±0.5	±0.2	-20 to 80	±0.1	For consumer electronics
CSTCE_G_A	8.00 to 12.50	±0.5	±0.2	-40 to 125	±0.1	For automotive electronics
CSTCE_V	12.51 to 19.99	±0.5	±0.3	-20 to 80	±0.3	For consumer electronics
CSTCV_X_Q	14.70 to 70.00	±0.5	±0.3	-40 to 125	±0.1	For automotive electronics
CSTCG_V	20.00 to 33.86	±0.5	±0.3	-20 to 80	±0.3	Ultra small type
CSTCW_X	20.00 to 70.00	±0.5	±0.2	-20 to 80	±0.1	For consumer electronics

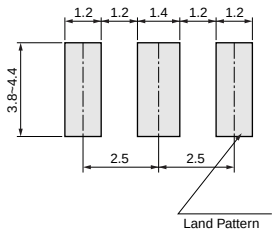
Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit



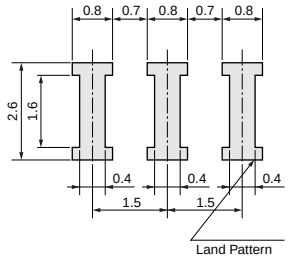
■ Standard Land Pattern Dimensions

CSTCC_G(_A)



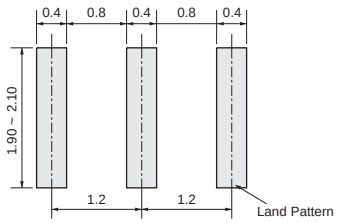
(in mm)

CSTCR_G(_A)



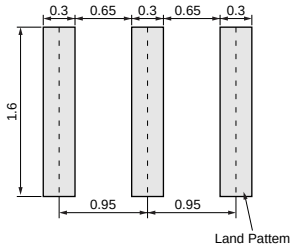
(in mm)

CSTCE_G(_A)



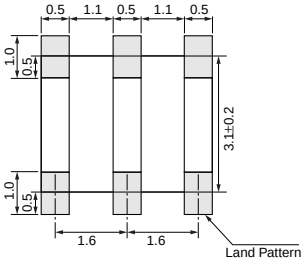
(in mm)

CSTCE_V



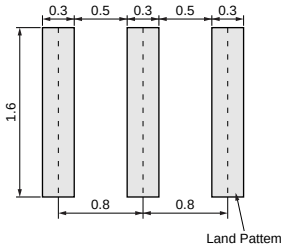
(in mm)

CSTCV_X_Q



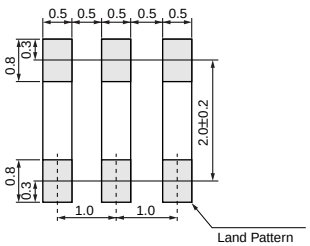
(in mm)

CSTCG_V



(in mm)

CSTCW_X

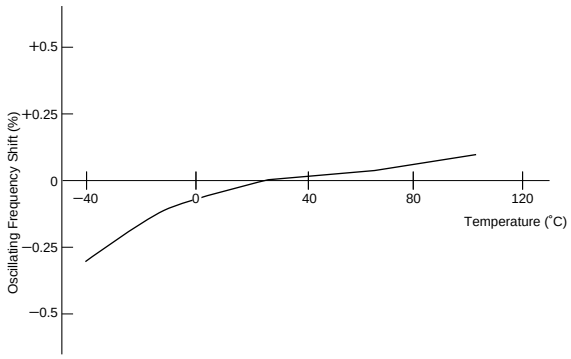


(in mm)

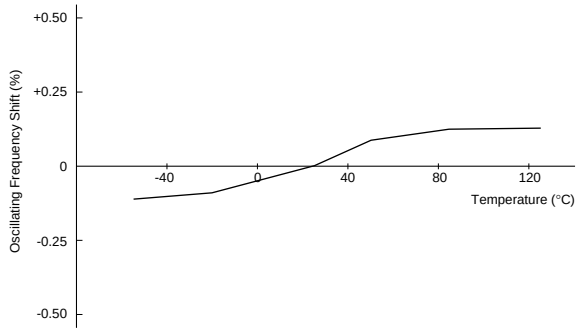
1

■ Oscillation Frequency Temperature Stability

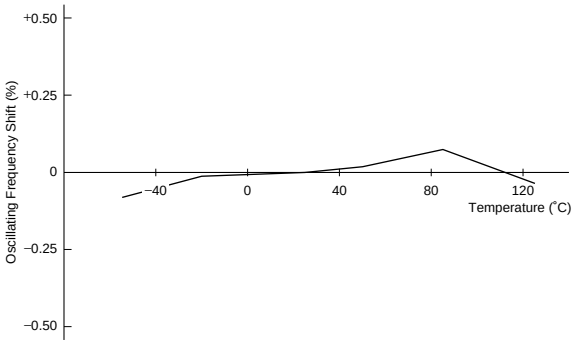
CSTCC_G



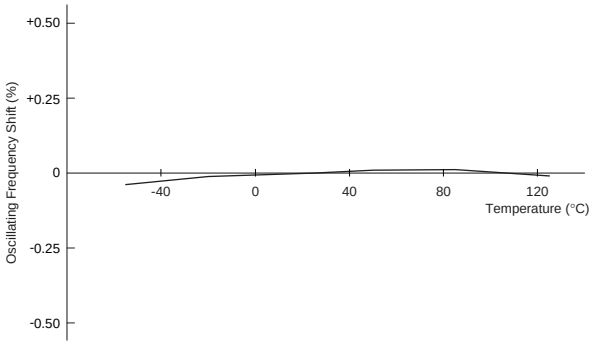
CSTCC_G_A



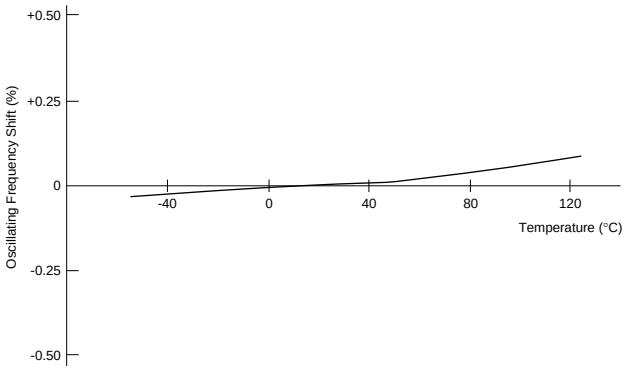
CSTCR_G(_A)



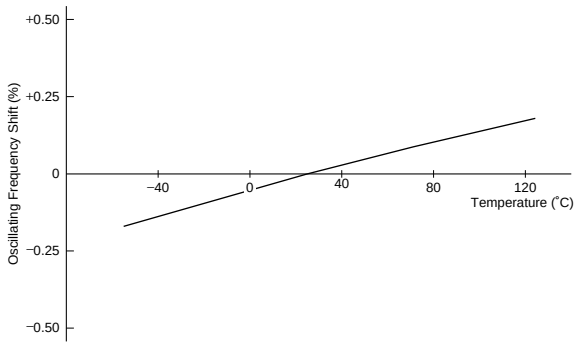
CSTCE_G(_A)



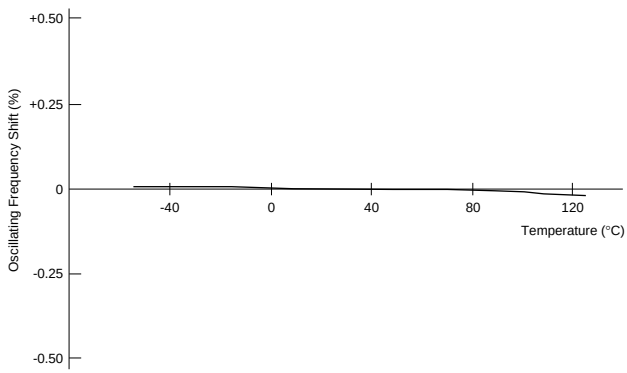
CSTCE_V



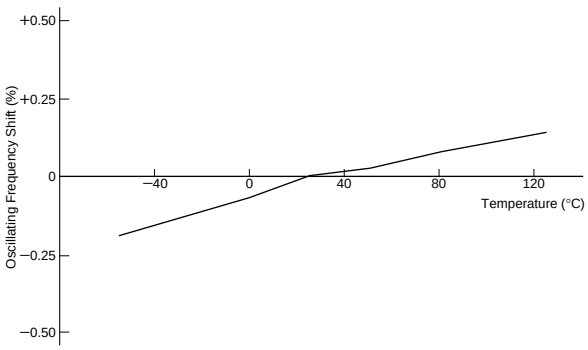
CSTCV_X_Q



CSTCG_V



CSTCW_X



Ceramic Resonators (CERALOCK®)

Chip Type Two-Terminals CSACV/W Series

Wide range of chip "CERALOCK" is now available.
This diverse series owes its development to MURATA's package technology expertise and original mass production techniques. It enables high-density mounting and further miniaturization of electronic equipment.

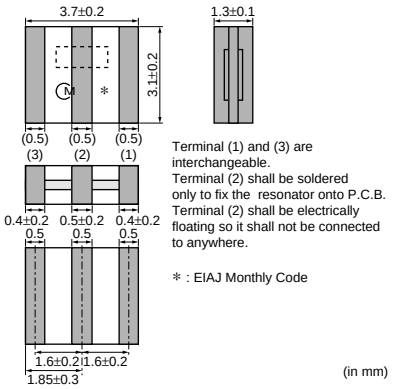
■ Features

1. The series is available in a wide frequency range.
2. The resonators are extremely small and have a low profile. (CSACW series)
3. No adjustment is necessary for oscillation circuits.

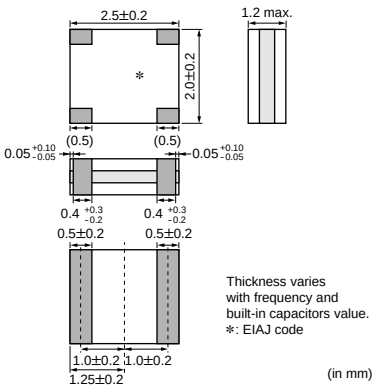
■ Applications

- Clock oscillators for microprocessors.
- Electronic control circuits for small electronic equipment.
- Automotive electronics. (CSACV_X_Q series)

CSACV_X_Q
14.70-70.00MHz



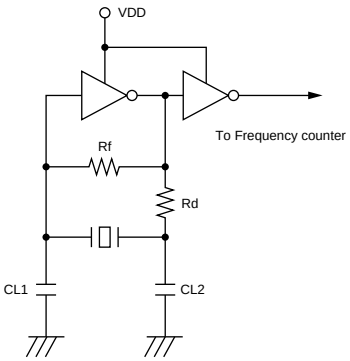
CSACW_X
20.00-70.00MHz



Part Number	Oscillating Frequency (MHz)	Initial Tolerance (%)	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSACV_X_Q	14.70 to 70.00	±0.5	±0.3	-40 to 125	±0.1	For automotive electronics
CSACW_X_53	20.00 to 24.99	±0.5	±0.2	-20 to 80	±0.1	For consumer electronics
CSACW_X_51	25.00 to 70.00	±0.5	±0.2	-20 to 80	±0.1	For consumer electronics

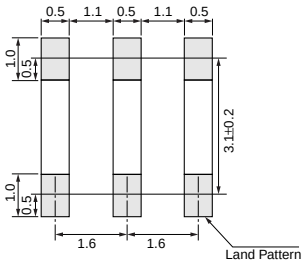
Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit



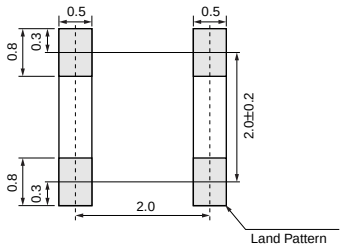
■ Standard Land Pattern Dimensions

CSACV_X_Q



(in mm)

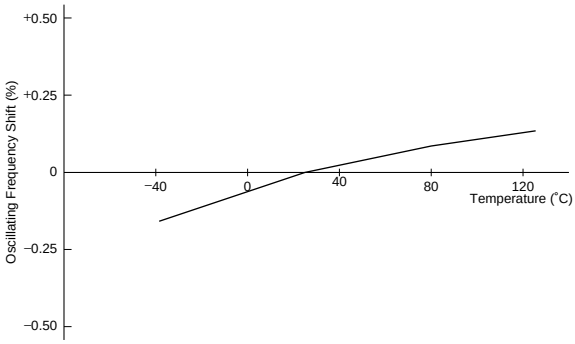
CSACW_X



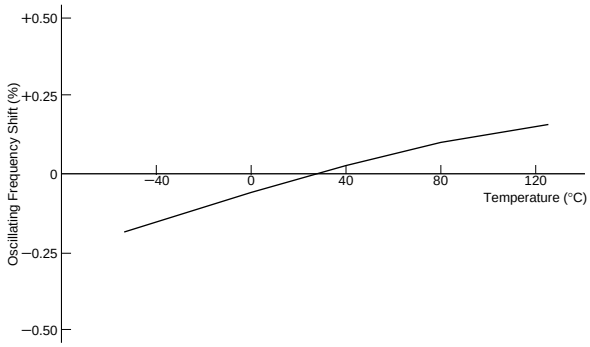
(in mm)

■ Oscillation Frequency Temperature Stability

CSACV_X_Q



CSACW_X



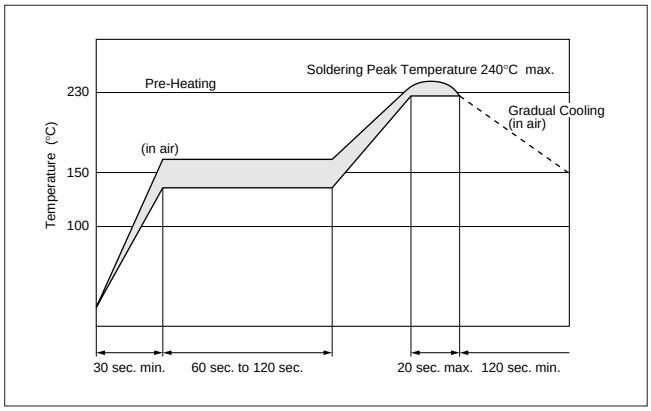
MHz Chip Type Notice (Soldering and Mounting)

1. Soldering Condition

(1) Reflow

One heat stress shown in the right profile is applied to resonator, then being place in natural condition for 1 hour, resonator shall be measure.

1. Pre-heating conditions shall be +140 to +160°C for 60 to 120 seconds. Ascending time up to +150°C shall be longer than 30 second.
2. Heating conditions shall be within 20 seconds at +230°C min., but peak temperature shall be lower than +240°C.



(2) Soldering Iron

Soldering iron of +270±5°C shall be placed 0.5mm above from electrode of resonator. Melting solder through soldering iron shall be applied to electrode for 3±1 seconds, then being place in natural condition for 24 hour, resonator shall be measured.

2. Wash

Some series are not withstand washing.
Please check the right list before use.

Series	Wash
CSTCC (Except 2.00-3.49MHz)	Available
CSTCV	Available
CSACV	Available
CSTCR	Not Available
CSTCC (Only 2.00-3.49MHz)	Not Available
CSTCW	Not Available
CSACW	Not Available
CSTCE	Not Available
CSTCG	Not Available

∗All automotive types are Available.

(1) Cleaning Solvent

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1

dT<=60°C (dT=Component-solvent)

*1 ex. In case the component at +90°C immerses into cleaning solvent at +60°C, then dT=30°C.

(3) Condition

1. Ultrasonic Wash
   1 minute max. in above solvent at +60°C max.
   (Frequency : 28kHz, Output : 20W/L)
2. Immersion Wash
   5 minutes max. in above solvent at +60°C max.
3. Shower or Rinse Wash
   5 minutes max. in above solvent at +60°C max.

(4) Drying

5 minutes max. by air blow at +80°C max.

(5) Others

1. Total washing time should be within 10 minutes.
2. Please insure the component is thoroughly evaluated in your application circuit.
3. The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

MHz Chip Type Notice

■ Notice (Storage and Operating Conditions)

CSTCC_G

Please do not apply excess mechanical stress to the component and terminals at soldering.
The component is recommended with placement machines with employ optical placement capabilities.
The component might be resulted in damage by excessivemechanical force. Please make sure that you have evaluated by using placementmachines before going into mass production. Do not use placement machines whichutilize mechanical positioning. Please contact Murata for details beforehand.

1. CSTCC_G (2.00MHz-3.49MHz)
   Conformal coating or washing to the component is not acceptable. Because it is not hermetically sealed.
2. CSTCC_G (3.50MHz-10.0MHz)
   Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.

■ Notice (Storage and Operating Conditions)

CSTCC_G_A/CSTCR_G_A/CSTCE_G_A

Please do not apply excess mechanical stress to the component and terminals at soldering.
Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.
The component is recommended with placement machines with employ optical placement capabilities.
The component might be resulted in damage by excessivemechanical force. Please make sure that you have evaluated by using placementmachines before going into mass production. Do not use placement machines whichutilize mechanical positioning. Please contact Murata for details beforehand.

■ Notice (Storage and Operating Conditions)

CSTCV_X_Q/CSACV_X_Q

Please do not apply excess mechanical stress to the component and terminals at soldering.
Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.
The component is recommended with placement machines which employ optical placement capabilities. In some cases, placement machines which utilize mechanical positioning may apply excessive mechanical force which might result in damage to the ceramic resonator.
Please contact Murata before mounting this product using placement machines which use mechanical positioning.

■ Notice (Storage and Operating Conditions)

CSTCW_X/CSACW_X

Please do not apply excess mechanical stress to the component and terminals at soldering.
Conformal coating or washing to the component is not acceptable. Because it is not hermetically sealed.

MHz Chip Type Notice

■ Notice (Storage and Operating Conditions)

CSTCR_G/CSTCE_G/CSTCE_V/CSTCG_V

Please do not apply excess mechanical stress to the component and terminals at soldering.
Conformal coating or washing to the component is not acceptable. Because it is not hermetically sealed.
The component is recommended with placement machines with employ optical placement capabilities.
The component might be resulted in damage by excessivemechanical force. Please make sure that you have evaluated by using placementmachines before going into mass production. Do not use placement machines whichutilize mechanical positioning. Please contact Murata for details beforehand.

■ Notice (Rating)

The component may be damaged if excess mechanical stress is applied.

■ Notice (Handling)

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

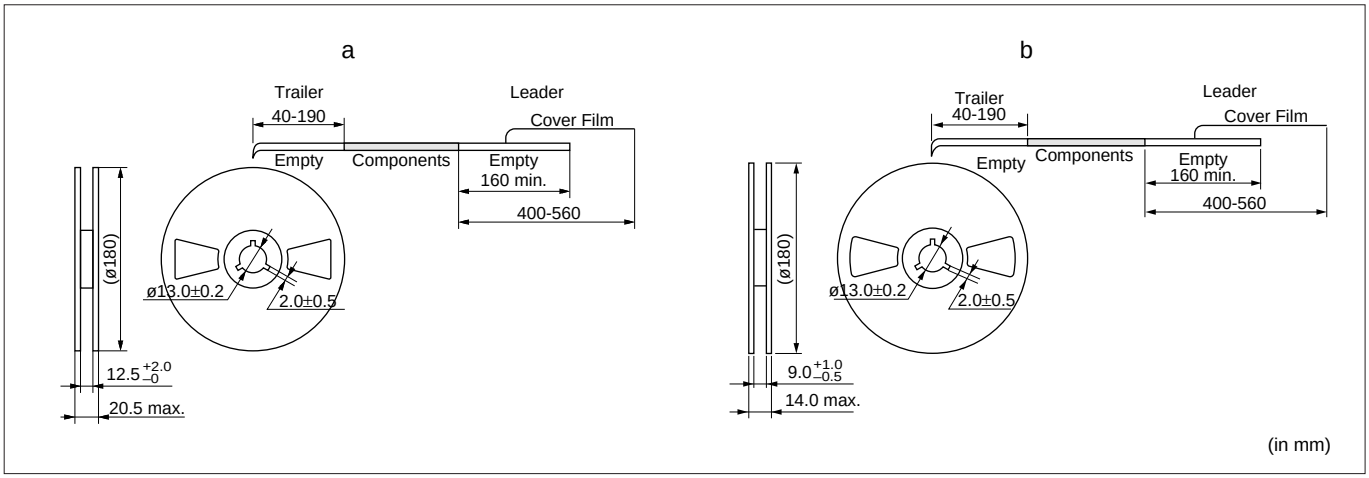
MHz Chip Type CSTC Series Packaging

■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Dimensions
CSTCC_G	2,000	6,000	500	a
CSTCC_G_A	2,000	6,000	500	a
CSTCR_G	3,000	9,000	500	a
CSTCR_G_A	3,000	9,000	500	a
CSTCE_G	3,000	9,000	500	b
CSTCE_G_A	3,000	9,000	500	b
CSTCE_V	3,000	9,000	500	b
CSTCV_X_Q	2,000	6,000	500	a
CSTCW_X	3,000	9,000	500	b
CSTCG_V	3,000	9,000	500	b

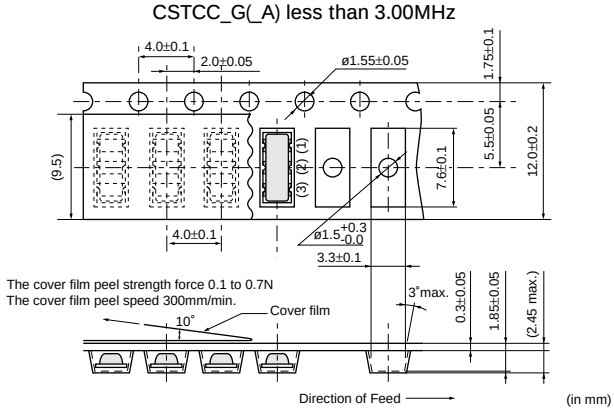
The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

■Dimensions of Reel

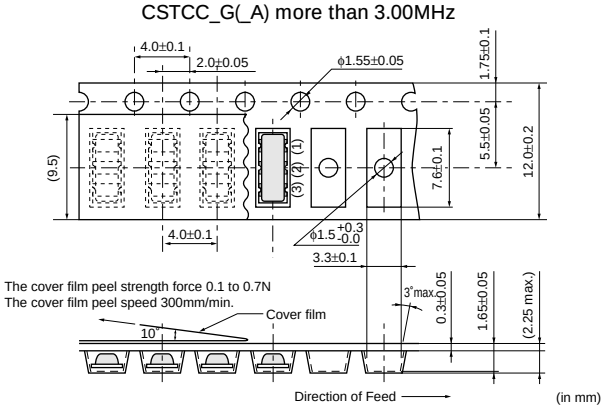


■ Dimensions of Taping

CSTCC_G(_A) less than 3.00MHz



CSTCC_G(_A) more than 3.00MHz



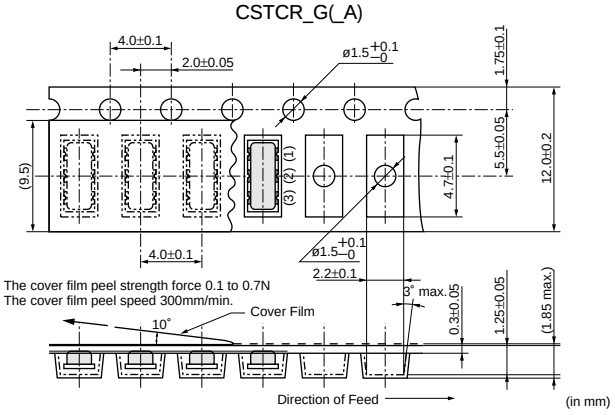
Continued on the following page.

MHz Chip Type CSTC Series Packaging

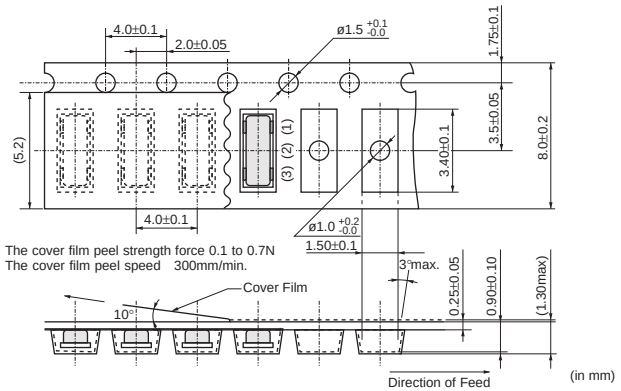
Continued from the preceding page.

■ Dimensions of Taping

CSTCR_G(_A)

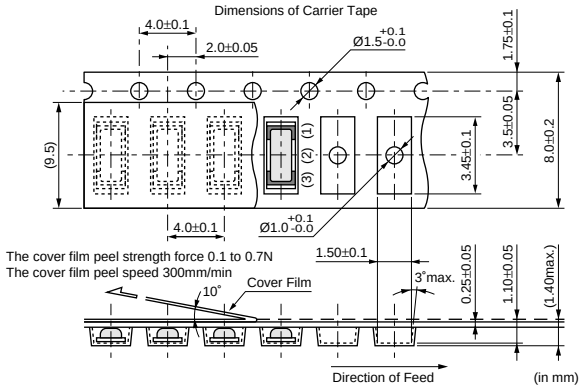


CSTCE_G(_A)

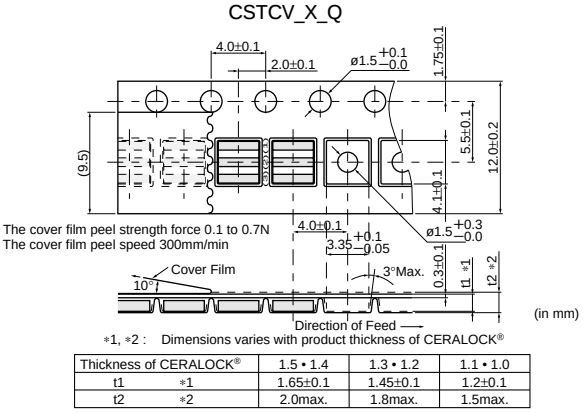


CSTCE_V

Dimensions of Carrier Tape



CSTCV_X_Q

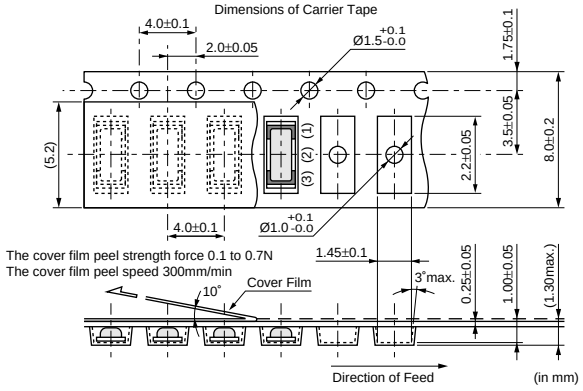


*1, *2 : Dimensions varies with product thickness of CERALOCK®

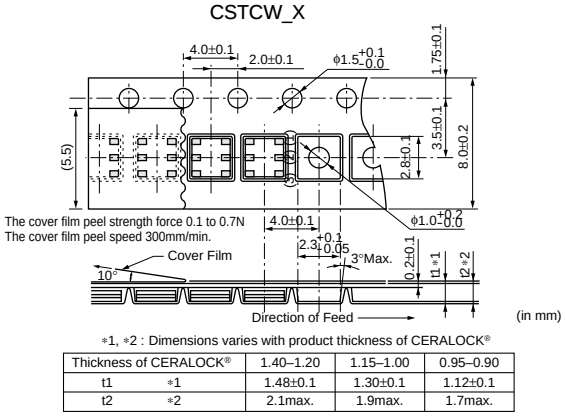
Thickness of CERALOCK®		1.5 • 1.4	1.3 • 1.2	1.1 • 1.0
t1	*1	1.65±0.1	1.45±0.1	1.2±0.1
t2	*2	2.0max.	1.8max.	1.5max.

CSTCG_V

Dimensions of Carrier Tape



CSTCW_X



*1, *2 : Dimensions varies with product thickness of CERALOCK®

Thickness of CERALOCK®		1.40–1.20	1.15–1.00	0.95–0.90
t1	*1	1.48±0.1	1.30±0.1	1.12±0.1
t2	*2	2.1max.	1.9max.	1.7max.

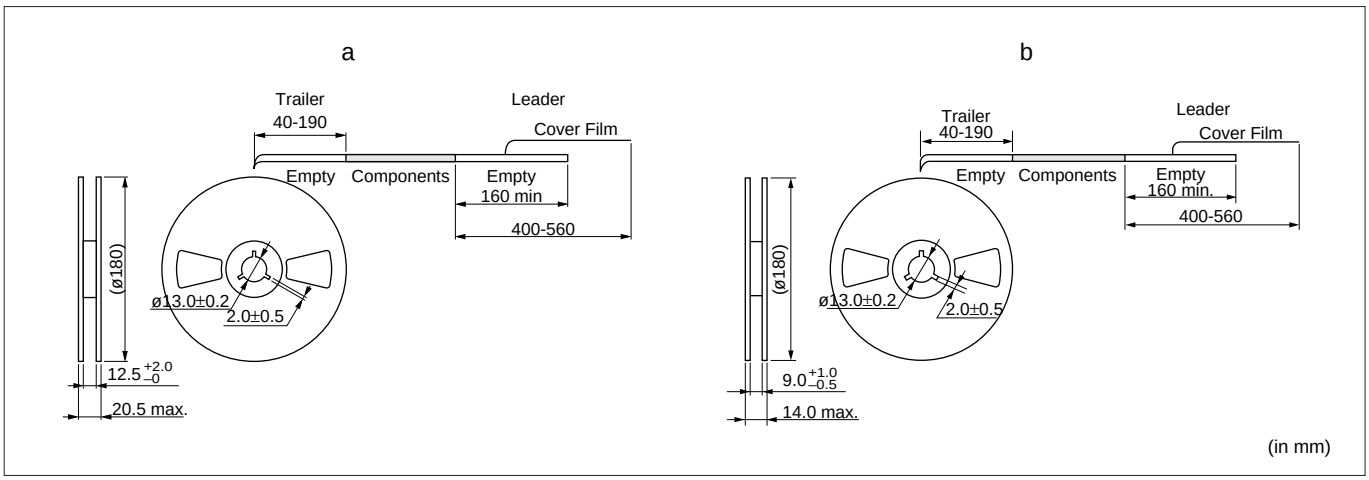
MHz Chip Type CSAC Series Packaging

■ Minimum Quantity

Part Number	Plastic Tape ø180mm	Plastic Tape ø330mm	Bulk	Dimensions
CSACV_X_Q	2,000	6,000	500	a
CSACW_X	3,000	9,000	500	b

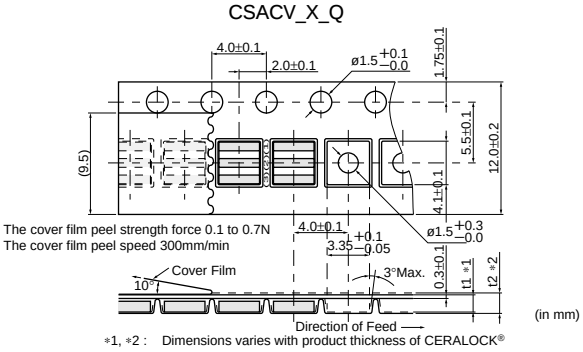
The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

■Dimensions of Reel



■ Dimensions of Taping

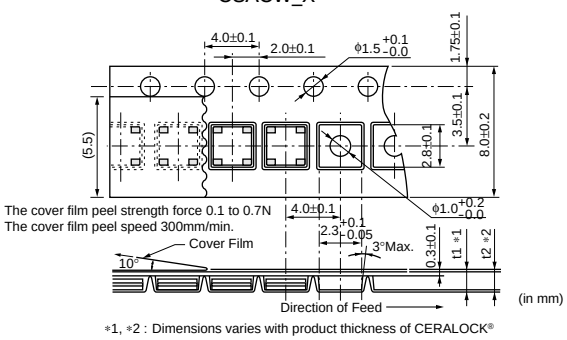
CSACV_X_Q



∗1, ∗2 : Dimensions varies with product thickness of CERALOCK®

Thickness of CERALOCK®		1.5 • 1.4	1.3 • 1.2	1.1 • 1.0
t1	∗1	1.65±0.1	1.45±0.1	1.2±0.1
t2	∗2	2.0max.	1.8max.	1.5max.

CSACW_X



∗1, ∗2 : Dimensions varies with product thickness of CERALOCK®

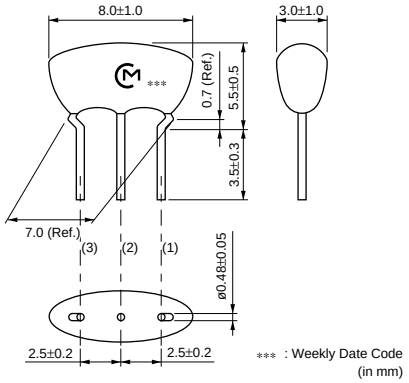
Thickness of CERALOCK®		1.40–1.20	1.15–1.00	0.95–0.90
t1	∗1	1.48±0.1	1.30±0.1	1.12±0.1
t2	∗2	2.1max.	1.9max.	1.7max.

Ceramic Resonators (CERALOCK®)

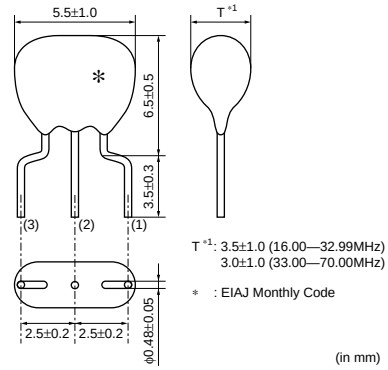
Lead Type Three-Terminals CSTLS Series

"CERALOCK" with built-in load capacitors.
MURATA's ceramic resonator, "CERALOCK", has been widely applied as the most suitable component for clock oscillators in a broad range of microprocessors. The CSTLS series can be used in the design of oscillation circuits not requiring external load capacitors, enabling both high-density mounting and cost reduction.

CSTLS_G
3.40-10.00MHz



CSTLS_X
16.00-70.00MHz



■ Features

1. Oscillation circuits do not require external load capacitors.
2. The series is stable over a wide temperature range.
3. The resonators are compact, light weight and exhibit superior shock resistance performance.
4. They enable the design of oscillator circuits requiring no adjustment.
5. The series is inexpensive and available in stable supply.
6. There are some variation of built-in capacitance value to apply various of IC.

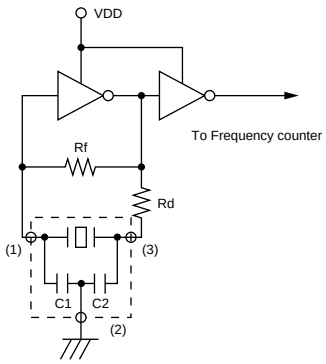
■ Applications

- DTMF generators.
- Clock oscillators for microcomputers.
- Remote control units.
- Automated office equipment.

Part Number	Oscillating Frequency (MHz)	Initial Tolerance (%)	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSTLS_G	3.40 to 10.00	±0.5	±0.2	-20 to 80	±0.2	For consumer electronics
CSTLS_X	16.00 to 70.00	±0.5	±0.2	-20 to 80	±0.2	For consumer electronics

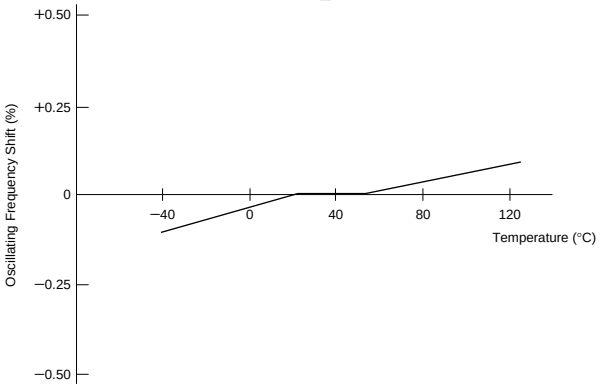
Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

■ Oscillation Frequency Measuring Circuit

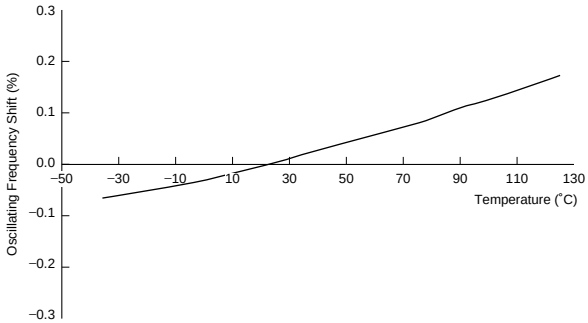


■ Oscillation Frequency Temperature Stability

CSTLS_G



CSTLS_X



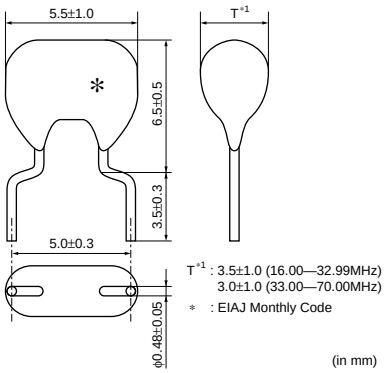
3

Ceramic Resonators (CERALOCK®)

Lead Type Two-Terminals CSALS Series

"CERALOCK" with two leaded terminals.
The CSALS series ceramic resonator owe their development to MURATA's innovative expert technologies and the application of mass production techniques typically utilized in the manufacture of piezoelectric ceramic components. Because of their high mechanical Q and consistent high quality, CSALS series are ideally suited to microprocessor and remote control unit applications.
In addition, MURATA offers a special "CERALOCK" version suitable for automatic insertion utilizing tape and reel and other packaging forms. For further information, please contact your local MURATA representative office or authorized distributor.

CSALS_X
16.00-70.00MHz



4

■ Features

1. The series is stable over a wide temperature range and with respect to long-term aging.
2. The series comprises fixed, tuned, solid-state devices.
3. The resonators are miniature and light weight.
4. They exhibit excellent shock resistance performance.
5. Oscillating circuits requiring no adjustment can be designed by utilizing these resonators in conjunction with transistors or appropriate ICs.

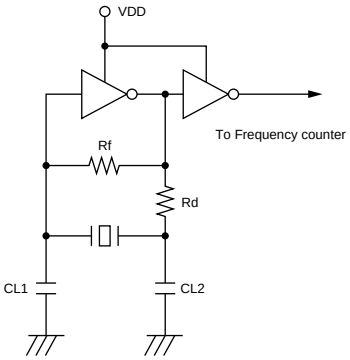
■ Applications

- Square-wave and sine-wave oscillator.
- Clock generator for microprocessors.
- Remote control systems.

Part Number	Oscillating Frequency (MHz)	Initial Tolerance (%)	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSALS_X	16.00 to 70.00	±0.5	±0.2	-20 to 80	±0.2	For consumer electronics

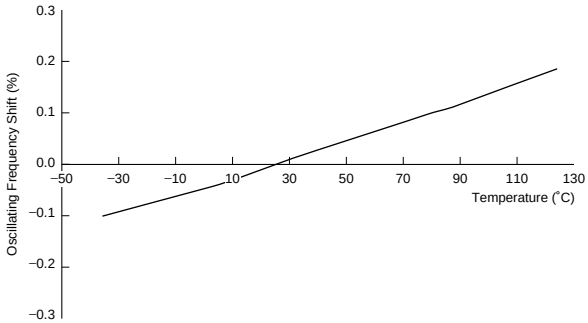
Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

■ Oscillation Frequency Measuring Circuit



■ Oscillation Frequency Temperature Stability

CSALS_X



4

MHz Lead Type Notice

■ Notice (Soldering and Mounting)

The component cannot be withstand washing.

■ Notice (Storage and Operating Conditions)

Please do not apply excess mechanical stress to the component and lead terminals at soldering.
Conformal coating or washing to the component is not acceptable. Because it is not hermetically sealed.

■ Notice (Rating)

The component may be damaged if excess mechanical stress is applied.

■ Notice (Handling)

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

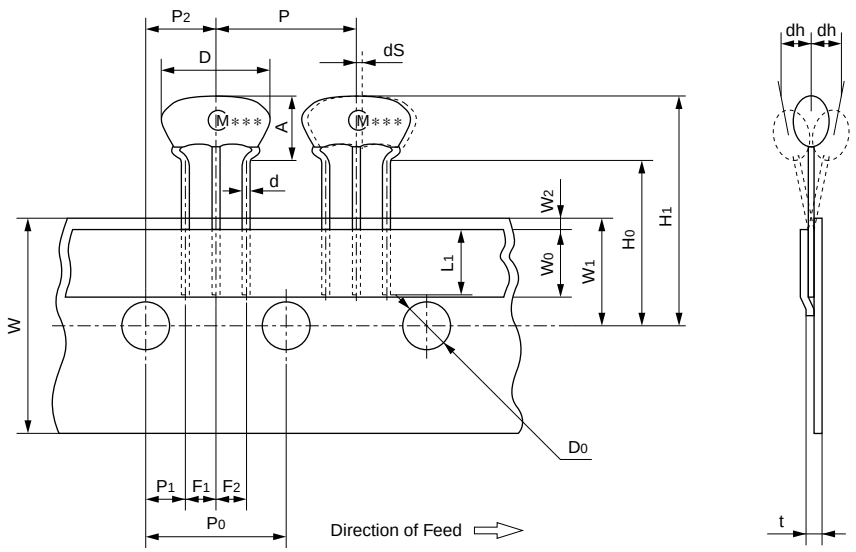
MHz Lead Type CSTLS Series Packaging

■ Minimum Quantity

Part Number	Ammo Pack	Bulk
CSTLS_G (3.40 to 10.0MHz)	2,000	500
CSTLS_X (16.00 to 70.00MHz)	2,000	500

The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

■ Tape Dimensions of CSTLS_G



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	8.0	±1.0	
Height of resonator	A	5.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L_1	5.0 min.	–	
Pitch of component	P	12.7	±0.5	Tolerance for Pitches 10xP_0=127±1
Pitch of sprocket hole	P_0	12.7	±0.2	
Length from sprocket hole center to lead	P_1	3.85	±0.5	
Length from sprocket hole center to component center	P_2	6.35	±0.5	
Lead spacing (I)	F_1	2.5	±0.2	
Lead spacing (II)	F_2	2.5	±0.2	
Slant to the forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W_0	6.0 min.	–	Hold down tape does not exceed the carrier tape.
Position of sprocket hole	W_1	9.0	±0.5	
Gap of hold down tape and carrier tape	W_2	0	$^{+0.5}_{-0}$	
Distance between the center of sprocket hole and lead stopper	H_0	18.0	±0.5	
Total heigth of resonator	H_1	23.5	±1.0	
Diameter of sprocket hole	D_0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

Continued on the following page.

MHz Lead Type CSTLS Series Packaging

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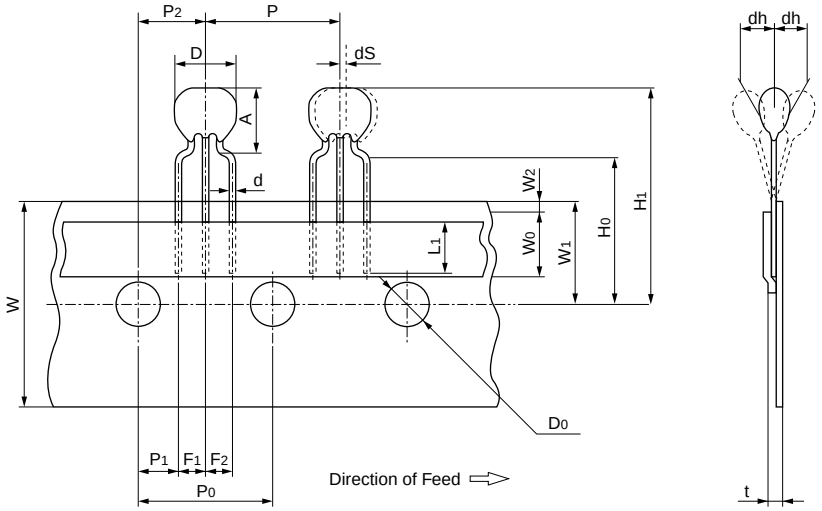
■ Tape Dimensions of CSTLS_X



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	A	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L_1	5.0 min.	–	
Pitch of component	P	12.7	±0.5	Tolerance for Pitches 10xP_0=127±1
Pitch of sprocket hole	P_0	12.7	±0.2	
Length from sprocket hole center to lead	P_1	3.85	±0.5	
Length from sprocket hole center to component center	P_2	6.35	±0.5	
Lead spacing (I)	F_1	2.5	±0.2	
Lead spacing (II)	F_2	2.5	±0.2	
Slant to the forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W_0	6.0 min.	–	Hold down tape doesn't exceed the carrier tape.
Position of sprocket hole	W_1	9.0	±0.5	
Gap of hold down tape and carrier tape	W_2	0	$^{+0.5}_{-0.0}$	
Distance between the center of sprocket hole and lead stopper	H_0	18.0	±0.5	
Total heigth of resonator	H_1	24.5	±0.1	
Diameter of sprocket hole	D_0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

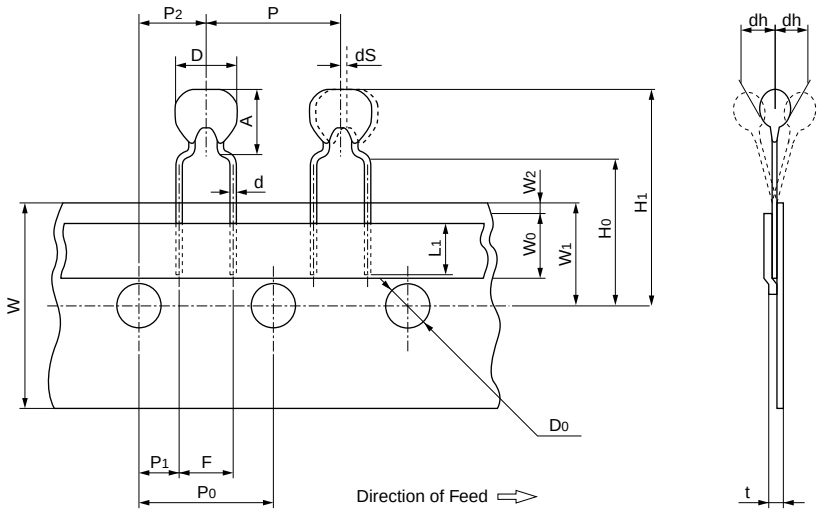
MHz Lead Type CSALS Series Packaging

■ Minimum Quantity

Part Number	Ammo Pack	Bulk
CSALS_X (16.00 to 70.00MHz)	2,000	500

The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

■ Tape Dimensions of CSALS



Item	Code	Dimensions	Tolerance	Remarks
Width of diameter	D	5.5	±1.0	
Height of resonator	A	6.5	±0.5	
Dimensions of terminal	d	ø0.48	±0.05	
Lead length under the hold down tape	L_1	5.0 min.	———	
Pitch of component	P	12.7	±0.5	Tolerance for Pitches 10xP_0=127±1
Pitch of sprocket hole	P_0	12.7	±0.2	
Length from sprocket hole center to lead	P_1	3.85	±0.5	
Length from sprocket hole center to component center	P_2	6.35	±0.5	
Lead spacing	F	5.0	±0.3	
Slant to the forward or backward	dh	0	±1.0	1mm max.
Width of carrier tape	W	18.0	±0.5	
Width of hold down tape	W_0	6.0 min.	———	Hold down tape doesn't exceed the carrier tape.
Position of sprocket hole	W_1	9.0	±0.5	
Gap of hold down tape and carrier tape	W_2	0	+0.5 -0	
Distance between the center of sprocket hole and lead stopper	H_0	18.0	±0.5	
Total heigth of resonator	H_1	24.5	±1.0	
Diameter of sprocket hole	D_0	ø4.0	±0.2	
Total tape thickness	t	0.6	±0.2	
Body tilt	dS	0	±1.0	

(in mm)

Ceramic Resonators (CERALOCK®)

Chip Type Two-Terminals CSBFB Series

Can be reflow soldered and mounted by automatic placers. MURATA's original package technologies have enabled the development of the kHz band "CERALOCK". The series is perfect in miniature remote control units and AV modules.

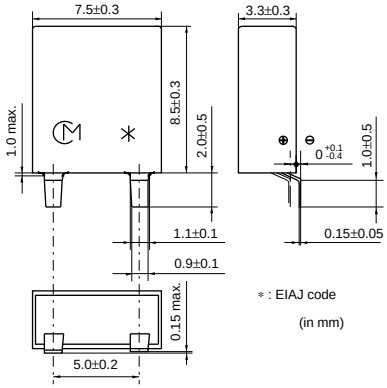
■ Features

1. The series withstands reflow soldering.
2. The series is mountable by automatic placers.
3. No adjustment is necessary for oscillation circuits.

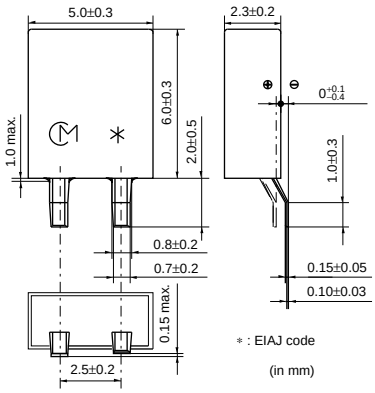
■ Applications

- Clock oscillators for microprocessors.
- OA equipment.
- AV modules.

CSBFB_J
430-519kHz



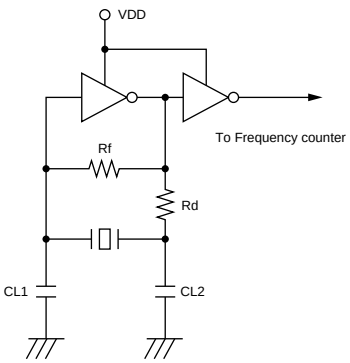
CSBFB_J
700-1250kHz



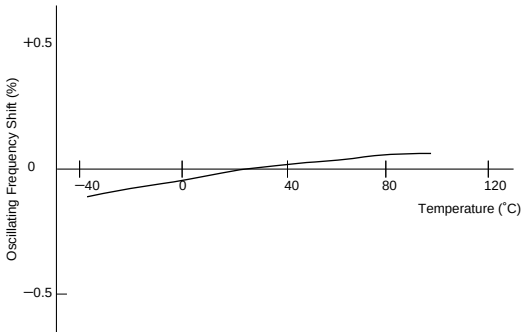
Part Number	Oscillating Frequency (kHz)	Initial Tolerance (%)	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSBFB_J	430 to 519, 700 to 1250	±0.5	±0.3	-20 to 80	±0.3	-

Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.

■ Oscillation Frequency Measuring Circuit



■ Oscillation Frequency Temperature Stability



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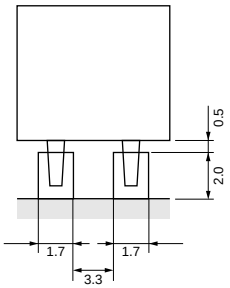
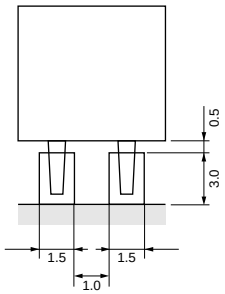
■ Standard Land Pattern Dimensions

CSBFB_J (430-519kHz)



(in mm)

CSBFB_J (700-1250kHz)



(in mm)

5

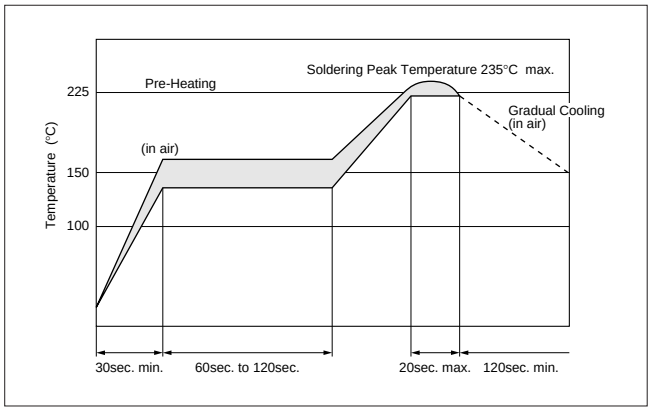
kHz Chip Type CSBFB_J 430-519kHz Notice (Soldering and Mounting)

1. Soldering Condition

(1) Reflow

Right profile of heat stress is applied to resonator, then being place in natural condition for 1 hour, resonator shall be measured.

1. Pre-heating conditions shall be +140 to +160°C for 60 to 120 seconds. Ascending time up to +150°C shall be longer than 30 second.
2. Heating conditions shall be within 20 seconds at +225°C min., but peak temperature shall be lower than +235°C.



(2) Soldering Iron

Soldering iron of +270±5°C shall be placed 0.5mm above from electrode of resonator. Melting solder through soldering iron shall be applied to electrode for 3±1 seconds, then being place in natural condition for 24 hour, resonator shall be measured.

2. Wash

(1) Cleaning Solvent

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1

dT<=60°C (dT=Component-solvent)

*1 ex. In case the component at +90°C immerses into cleaning solvent at +60°C, then dT=30°C.

(3) Condition

1. Ultrasonic Wash
   1 minute max. in above solvent at +60°C max.
   (Frequency : 28kHz, Output : 20W/L)
2. Immersion Wash
   5 minutes max. in above solvent at +60°C max.
3. Shower or Rinse Wash
   5 minutes max. in above solvent at +60°C max.

(4) Drying

5 minutes max. by air blow at +80°C max.

(5) Others

1. Total washing time should be within 10 minutes.
2. Please insure the component is thoroughly evaluated in your application circuit.
3. The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

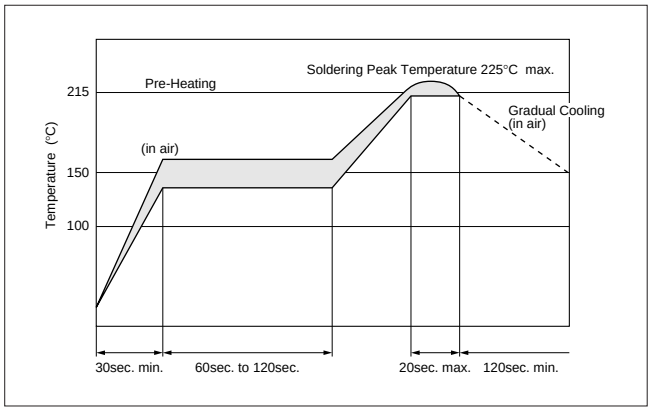
kHz Chip Type CSBFB_J 700-1250kHz Notice (Soldering and Mounting)

1. Soldering Condition

(1) Reflow

Right profile of heat stress is applied to resonator, then being place in natural condition for 1 hour, resonator shall be measured.

1. Pre-heating conditions shall be +140 to +160°C for 60 to 120 seconds. Ascending time up to +150°C shall be longer than 30 second.
2. Heating conditions shall be within 20 seconds at +215°C min., but peak temperature shall be lower than +225°C.



(2) Soldering Iron

Soldering iron of +270±5°C shall be placed 0.5mm above from electrode of resonator. Melting solder through soldering iron shall be applied to electrode for 3±1 seconds, then being place in natural condition for 24 hour, resonator shall be measured.

2. Wash

(1) Cleaning Solvent

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW

(2) Temperature Difference : dT *1

dT<=60°C (dT=Component-solvent)

*1 ex. In case the component at +90°C immerses into cleaning solvent at +60°C, then dT=30°C.

(3) Condition

1. Ultrasonic Wash
   1 minute max. in above solvent at +60°C max.
   (Frequency : 28kHz, Output : 20W/L)
2. Immersion Wash
   5 minutes max. in above solvent at +60°C max.
3. Shower or Rinse Wash
   5 minutes max. in above solvent at +60°C max.

(4) Drying

5 minutes max. by air blow at +80°C max.

(5) Others

1. Total washing time should be within 10 minutes.
2. Please insure the component is thoroughly evaluated in your application circuit.
3. The component may be damaged if it is washed with chlorine, petroleum, or alkali cleaning solvent.

Ceramic Resonators (CERALOCK®)

Lead Type Two-Terminals CSBLA Series

"CERALOCK" with two leaded terminals.
The CSBLA series ceramic resonator owe their development to MURATA's innovative expert technologies and the application of mass production techniques typically utilized in the manufacture of piezoelectric ceramic components. Because of their high mechanical Q and consistent high quality, the CSBLA series are ideally suited to microprocessor and remote control unit applications.

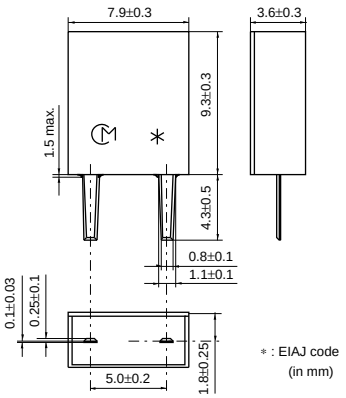
■ Features

1. The series is stable over a wide temperature range and with respect to long-term aging.
2. The series comprises fixed, tuned, solid-state devices.
3. The resonators are miniature and light weight.
4. They exhibit excellent shock resistance performance.
5. Oscillating circuits requiring no adjustment can be designed by utilizing these resonators in conjunction with transistors or appropriate ICs.

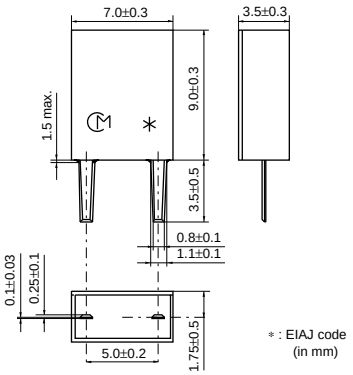
■ Applications

- Square-wave and sine-wave oscillator.
- Clock generator for microprocessors.
- Remote control systems.

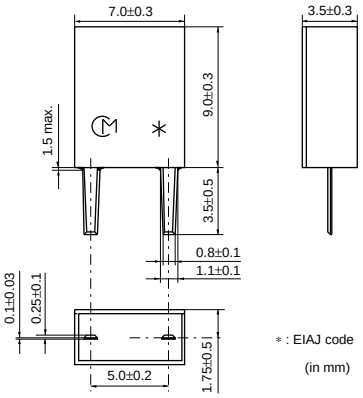
CSBLA_E
375-429kHz



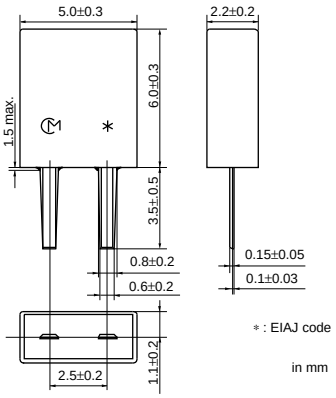
CSBLA_E
430-509kHz



CSBLA_E
510-699kHz



CSBLA_J
700-1250kHz

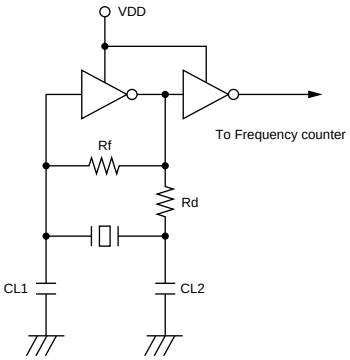


6

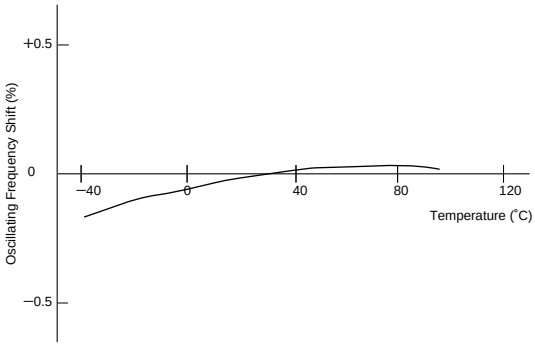
Part Number	Oscillating Frequency (kHz)	Initial Tolerance	Temp.Stability (%)	Temperature Range (°C)	Aging (10 years) (%)	Use
CSBLA_E	375 to 699	±2kHz	±0.3	-20 to 80	±0.3	-
CSBLA_J	700 to 1250	±0.5%	±0.3	-20 to 80	±0.3	-

Irregular or stop oscillation may occur under unmatched circuit conditions. Please check the actual conditions prior to use.
The order quantity should be an integral multiple of the "Minimum Quantity" shown in the packaging page.

■ Oscillation Frequency Measuring Circuit



■ Oscillation Frequency Temperature Stability



6

kHz Lead Type Notice

■ Notice (Soldering and Mounting)

CSBLA_E

The component cannot be withstand washing.

■ Notice (Soldering and Mounting)

CSBLA_J

(1) Cleaning Solvent

HCFC, Isopropanol, Tap water, Demineralized water, Cleanthrough750H, Pine alpha 100S, Techno care FRW.

(2) Temperature Difference:dT *1

dT<=30 C. (dT=Component-solvent)

*1 ex. In case the component at +90 C. immerses into cleaning solvent at +60 C., then dT=30 C.

(3) Condition

1. Ultrasonic Wash
   1 minute max. in above solvent at +60 C. max.
   (Frequency:28kHz, Output:20W/L)
2. Immersion Wash
   5 minutes max. in above solvent at +60 C. max.
3. Shower or Rinse Wash
   5 minutes max. in above solvent at +60 C. max.

(4) Drying

5 minutes max. by air blow at +80 C. max.

(5) Others

1. Total washing time should be within 10 minutes.
2. Please insure the component is thoroughly evaluated in your application circuit.
3. The component may be damaged if it is washed with alkali cleaning solvent.

kHz Type Notice

■ Notice (Storage and Operating Condition)

CSBFB_J

Please do not apply excess mechanical stress to the component and lead terminals at soldering.
Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.
Ultrasonic cleaning of the component is acceptable. However, the size of bath, size and thickness of PBC should be evaluated to confirm stable electrical characteristics are maintained.
In case of the bulk component, dry heating treatment (130 C. for 5 hours min.) is requiredbefore reflow soldering. Then, the component should be soldering within 48 hours after dry heating treatment.

■ Notice (Storage and Operating Condition)

CSBLA_E

Please do not apply excess mechanical stress to the component and lead terminals at soldering.
Conformal coating or washing to the component is not acceptable. Because it is not hermetically sealed.

■ Notice (Storage and Operating Condition)

CSBLA_J

Please do not apply excess mechanical stress to the component and lead terminals at soldering.
Conformal coating of the component is acceptable. However, the resin material, curing temperature, and other process conditions should be evaluated to confirm stable electrical characteristics are maintained.
Ultrasonic cleaning of the component is acceptable. However, the size of bath, size and thickness of PBC should be evaluated to confirm stable electrical characteristics are maintained.

■ Notice (Rating)

The component may be damaged if excess mechanical stress is applied.

■ Notice (Handling)

"CERALOCK" may stop oscillating or oscillate irregularly under improper circuit conditions.

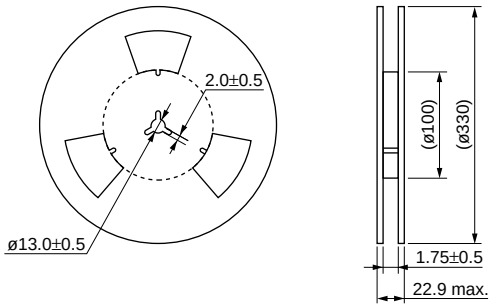
kHz Type Packaging

■ CSBFB Series Minimum Quantity

Part Number	Plastic Tape ø330mm	Bulk
CSBFB_J (430 to 519kHz)	1,500	500
CSBFB_J (700 to 1250kHz)	3,000	1,000

The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

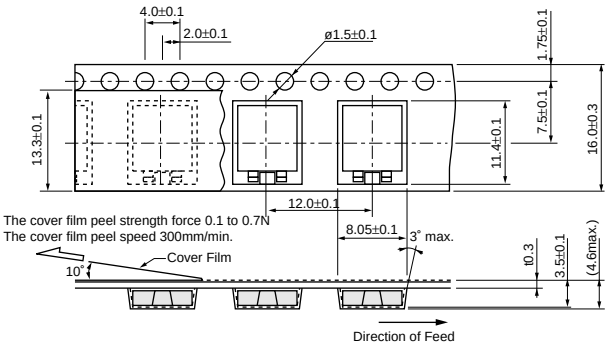
■Dimensions of Reel



(in mm)

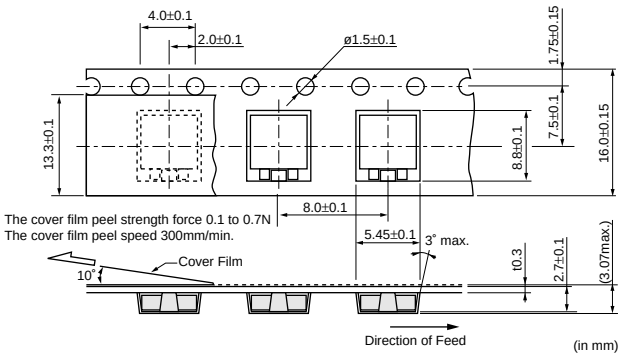
■ Dimensions of Taping

CSBFB_J 430-519kHz



(in mm)

CSBFB_J 700-1250kHz



(in mm)

■ CSBLA Series Minimum Quantity

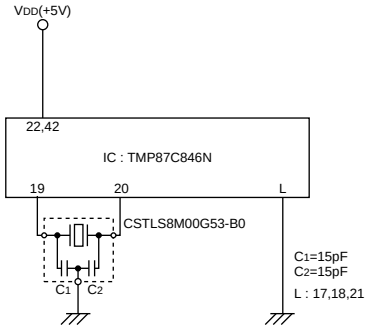
Part Number	Magazine	Bulk
CSBLA_E	50	500
CSBLA_J	100	1,000

The order quantity should be an integral multiple of the "Minimum Quantity" shown above. (pcs.)

Application Circuits Utilizing

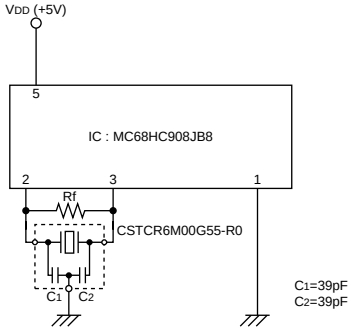
■ TMP87CM40AN (TOSHIBA)

8-bit Microcomputer



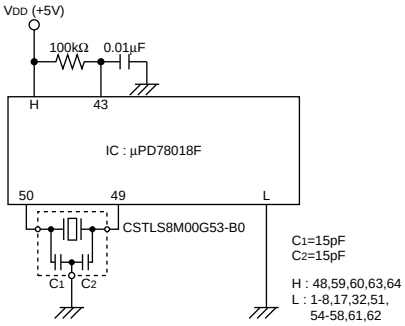
■ MC68HC908JB8 (MOTOROLA)

8-bit Microcomputer



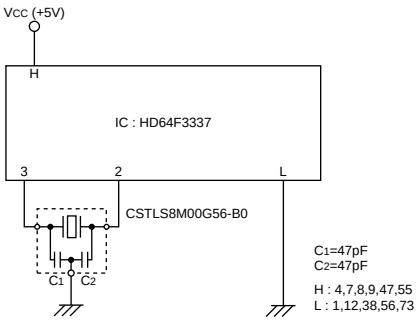
■ uPD78018F (NEC)

8-bit Microcomputer



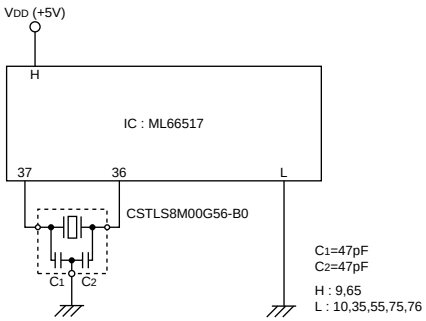
■ HD64F3337 (HITACHI)

8-bit Microcomputer



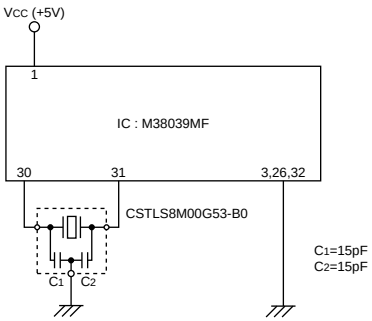
■ ML66517 (OKI)

8-bit Microcomputer



■ M38039MF (MITSUBISHI)

8-bit Microcomputer



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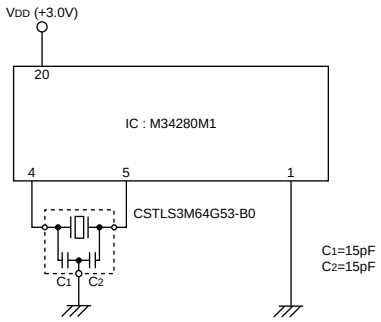
Application Circuits Utilizing

Continued from the preceding page.

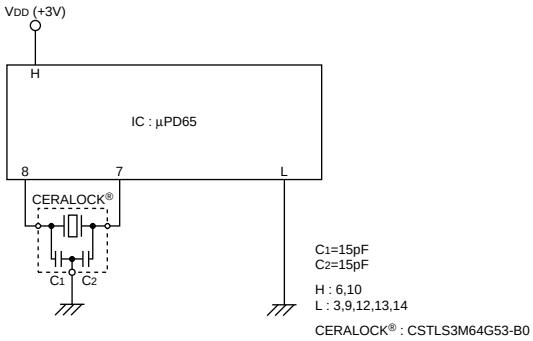
■ M34280M1 (MITSUBISHI)

Remote Control Unit



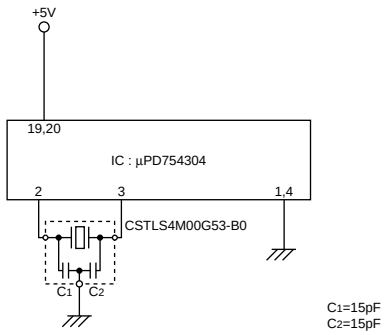
■ uPD65 (NEC)

Speech Synthesizer



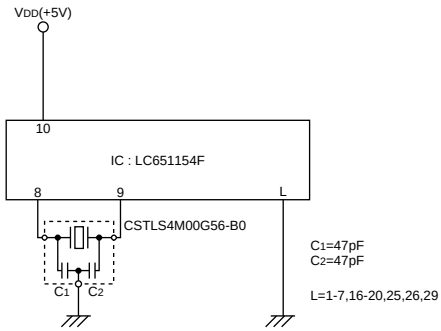
■ uPD754304 (NEC)

4-bit Microcomputer



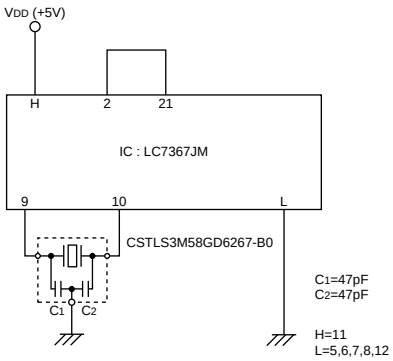
■ LC651154F (SANYO)

4-bit Microcomputer



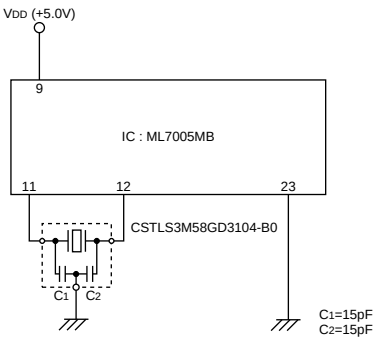
■ LC7367JM (SANYO)

Tone/Pulse Dialer



■ ML7005MB (OKI)

Tone/Pulse Dialer



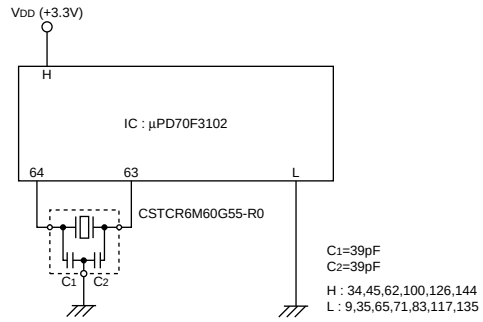
Continued on the following page.

Application Circuits Utilizing

Continued from the preceding page.

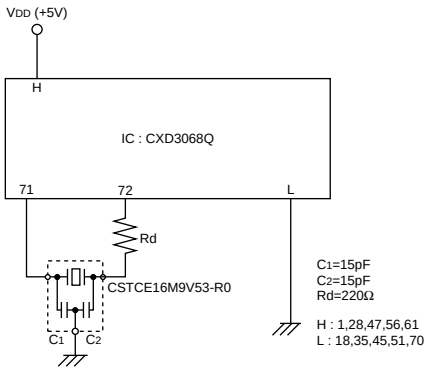
■ uPD70F3102GJ (NEC)

32-bit Microcomputer



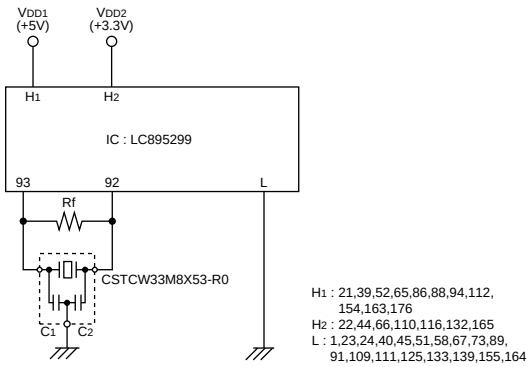
■ CXD3068Q (SONY)

Digital Signal Processing IC for CD



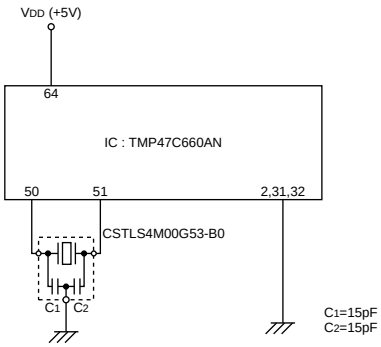
■ LC895299 (SANYO)

Error Correction of CD-ROM LSI



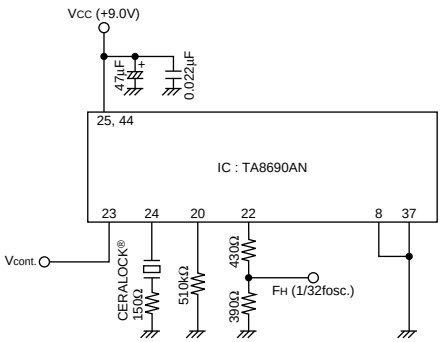
■ TMP47C660AN (TOSHIBA)

4-bit Microcomputer



■ TA8690AN (TOSHIBA)

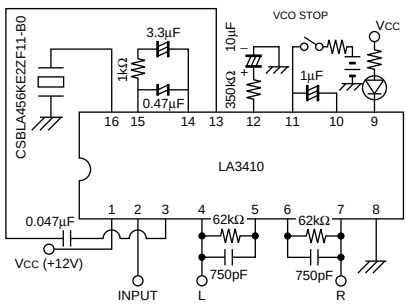
TV Horizontal/Compatible with Synthesizer Circuit



CERALOCK® : CSBLA503KEZZF46-B0

■ LA3410 (SANYO)

FM Stereo MPX



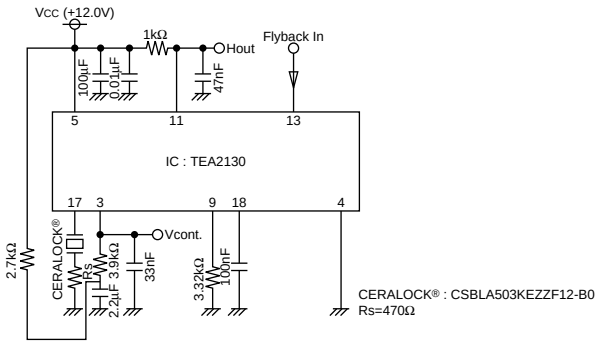
Continued on the following page.

Application Circuits Utilizing

Continued from the preceding page.

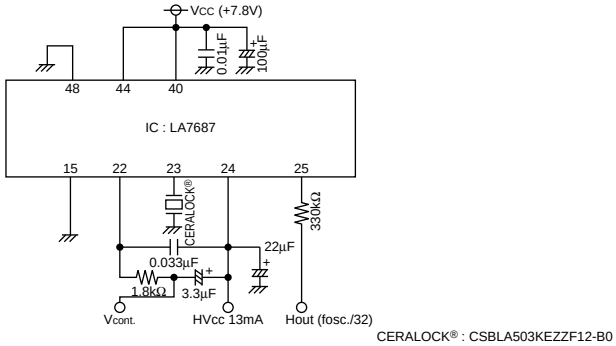
■ TEA2130 (THOMSON)

TV Horizontal/Compatible with Synthesizer Circuit

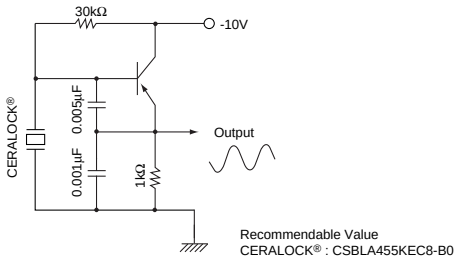


■ LA7687 (SANYO)

TV Horizontal/Compatible with Synthesizer Circuit



■ Oscillation Circuit Incorporationg Transistor



⚠Note:

1. Export Control
   〈For customers outside Japan〉
   Murata products should not be used or sold for use in the development, production, stockpiling or utilization of any conventional weapons or mass-destructive weapons (nuclear weapons, chemical or biological weapons, or missiles), or any other weapons.
   〈For customers in Japan〉
   For products which are controlled items subject to the “Foreign Exchange and Foreign Trade Law” of Japan, the export license specified by the law is required for export.
2. Please contact our sales representatives or product engineers before using our products listed in this catalog for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property, or when intending to use one of our products for other applications than specified in this catalog.
   ① Aircraft equipment ② Aerospace equipment
   ③ Undersea equipment ④ Power plant equipment
   ⑤ Medical equipment ⑥ Transportation equipment (vehicles, trains, ships, etc.)
   ⑦ Traffic signal equipment ⑧ Disaster prevention / crime prevention equipment
   ⑨ Data-processing equipment ⑩ Application of similar complexity and/or reliability requirements to the applications listed in the above
3. Product specifications in this catalog are as of May 2002. They are subject to change or our products in it may be discontinued without advance notice. Please check with our sales representatives or product engineers before ordering. If there are any questions, please contact our sales representatives or product engineers.
4. Please read rating and ⚠CAUTION (for storage and operating, rating, soldering and mounting, handling) in this catalog to prevent smoking and/or burning, etc.
5. This catalog has only typical specifications because there is no space for detailed specifications. Therefore, please approve our product specification or transact the approval sheet for product specification before ordering.
6. Please read CAUTION and Notice in this catalog for safety. This catalog has only typical specifications. Therefore you are requested to approve our product specification or to transact the approval sheet for product specification, before ordering.
7. Please note that unless otherwise specified, we shall assume no responsibility whatsoever for any conflict or dispute that may occur in connection with the effect of our and/or third party's intellectual property rights and other related rights in consideration of your using our products and/or information described or contained in our catalogs. In this connection, no representation shall be made to the effect that any third parties are authorized to use the rights mentioned above under licenses without our consent.
8. No ozone depleting substances (ODS) under the Montreal Protocol are used in our manufacturing process.

muRata **Murata Manufacturing Co., Ltd.**

http://www.murata.com/

Head Office
2-26-10, Tenjin Nagaokakyo-shi, Kyoto 617-8555, Japan Phone: 81-75-951-9111

International Division
3-29-12, Shibuya, Shibuya-ku, Tokyo 150-0002, Japan
Phone: 81-3-5469-6123 Fax: 81-3-5469-6155 E-mail: intl@murata.co.jp